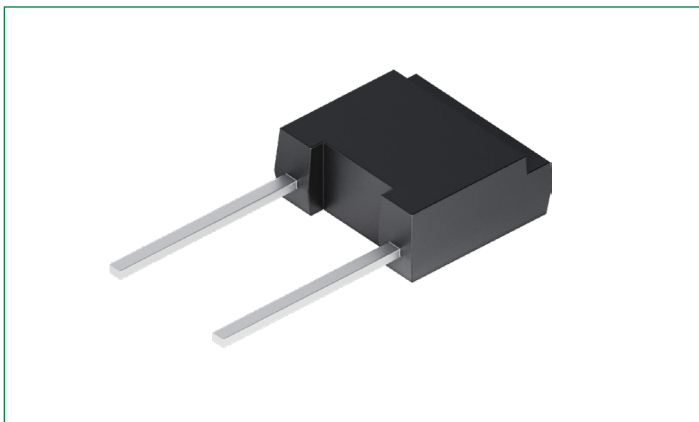


DSA1

Avalanche Diode

IEC60747



Preliminary Data

Type	V_{RSM} (V)	$V_{(BR)min}$ (V)	V_{RRM} (V)
DSA1-12D	1300	1300	1200
DSA1-16D	1700	1750	1600
DSA1-18D	1900	1950	1800

Features:

- Plastic standard package
- Planar passivated chips

Advantages:

- Space and weight savings
- Simple PCB mounting
- Reduced protection circuits
- Improved temperature and power cycling

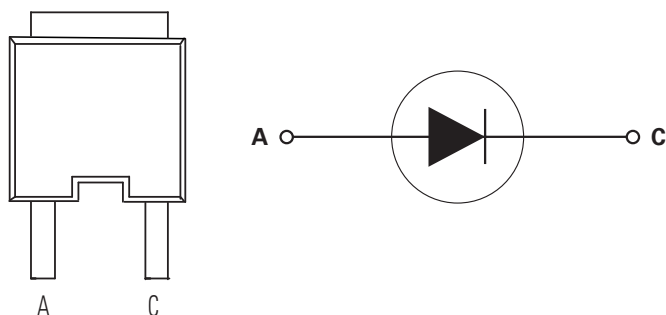
Applications:

- Low power rectifiers
- Field supply for DC motors
- Power supplies
- High voltage rectifiers

Product Summary

Characteristic	Value	Unit
V_{RRM}	1200–1800	V
$I_{F(RMS)}$	7	A
I_{FAVM}	2.3	A

Pinout Diagram



A: Anode; **C:** Cathode

Maximum Ratings

Symbol	Characteristics	Conditions	Value	Units
$I_{F(RMS)}$	RMS Forward Current	$T_{VJ} = T_{VJM}$	7	A
$I_{F(AVJM)}$	Maximum Average Forward Current	$T_{amb} = 45^{\circ}C; R_{thJA} = 38 K/W; 180^{\circ}$ sine	2.3	A
		$T_{amb} = 45^{\circ}C; R_{thJA} = 80 K/W; 180^{\circ}$ sine	1.3	A
P_{RSM}	Maximum Surge Reverse Power Dissipation	$T_{VJM}; t_p = 10$ ms	1.6	kW
I_{FSM}	Maximum Surge Forward Current	$T_{VJ} = 45^{\circ}C; t = 10$ ms (50 Hz), sine	110	A
		$T_{VJ} = 45^{\circ}C; t = 8.3$ ms (60 Hz), sine	118	
		$T_{VJ} = 150^{\circ}C; t = 10$ ms (50 Hz), sine	100	A
		$T_{VJ} = 150^{\circ}C; t = 8.3$ ms (60 Hz), sine	104	
I^2t	I^2t Value for Fusing	$T_{VJ} = 45^{\circ}C; t = 10$ ms (50 Hz), sine	60	A ² s
		$T_{VJ} = 45^{\circ}C; t = 8.3$ ms (60 Hz), sine	58	
		$T_{VJ} = 150^{\circ}C; t = 10$ ms (50 Hz), sine	50	A ² s
		$T_{VJ} = 150^{\circ}C; t = 8.3$ ms (60 Hz), sine	45	
T_{VJ}	Virtual Junction Temperature	–	–40 to +150	°C
T_{VJM}	Maximum Virtual Junction Temperature	–	150	°C
T_{stg}	Storage Temperature	–	–40 to +150	°C

Static Characteristics

Symbol	Characteristics	Conditions		Value		Units
				Typ.	Max.	
I_R	Reverse Current	$T_{VJ} = T_{VJM}$	$V_R = V_{RRM}$	–	0.7	mA
V_F	Forward Voltage	$I_F = 7$ A	$T_{VJ} = 25^{\circ}C$	–	1.34	V
V_{TO}	Threshold Voltage	For power-loss calculation only		–	0.8	V
r_T	Slope Resistance	$T_{VJ} = T_{VJM}$		–	67	mΩ

Thermal Specifications

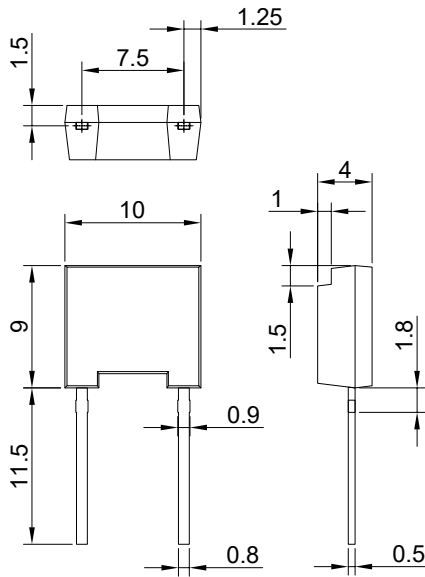
Symbol	Characteristics	Conditions	Value		Unit
			Typ.	Max.	
R_{thJA}	Maximum Thermal Resistance, Junction to Ambient	Forced Air Cooling with 1.5 m/s; $T_{amb} = 45^{\circ}C$	–	38	K/W
		Soldered on to PC board; $T_{amb} = 45^{\circ}C$	–	80	K/W

Physical Specifications

Symbol	Characteristics	Conditions	Value		Unit
			Typ.	Max.	
wt	Weight	–	0.8	–	g
d_s	Creep distance on surface	–	–	8.5	mm
d_A	Strike distance through air	–	–	6.7	mm
a	Acceleration	–	–	100	m/s ²

Part Outline Drawing

Dimension in mm (1 mm = 0.0394")



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Part of:

